Gate Resistance	R_G	V_{GS}=0V, V_{DS}				
Input Capacitance	C_{iss}		-	840	-	
Output Capacitance	C_{oss}		-	147		
			-	4.9	-	
Total Gate Charge	Q_g(10V)		-		-	
Total Gate Charge	Q_g(4.5V)	V_{DD}=50V, I_D=15A, V_{GS}=10V	-	9	-	
Gate to Source Charge	Q_{gs}					
Gate to Drain (Miller) Charge	Q_{gd}				-	
Turn on Delay Time	$t_{d(on)}$		-	6	-	
Rise time	t_r	V_{DD}=50V, I_D=15A, V_{GS}=10V,	-	3	-	ns
Turn off Delay Time	$t_{d(off)}$	R_G=10 ,	-	13	-	
Fall Time	t_f		-	3	-	

Reverse Diode Characteristics

Diode Forward Voltage	V_{SD}	V_{GS}=0V, I_F=20A	-	0.9	1.2	V
Reverse Recovery Time	t_{rr}	V_R=50V, I_F=15A, dI_F/dt=500A/ s	-	30	-	ns
Reverse Recovery Charge	Q_{rr}		-	105	-	nC

Fig 1. Typical Output Characteristics	Figure 2. On-Resistance vs. Gate-Source Voltage

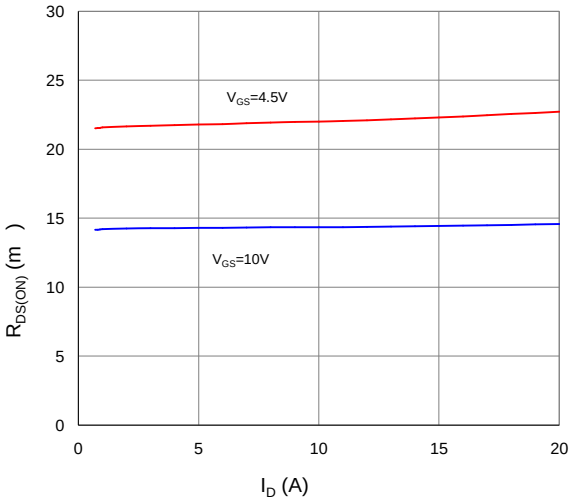
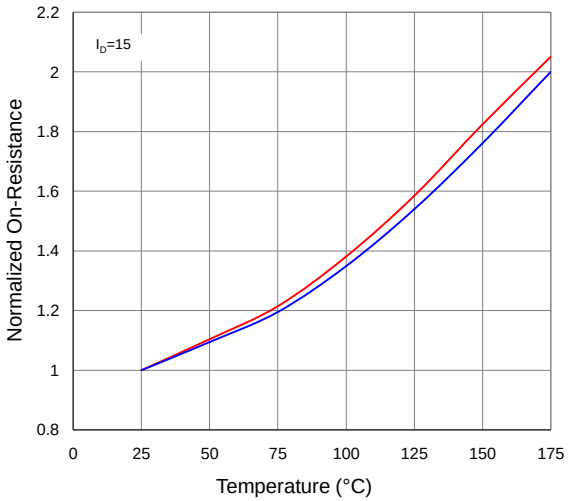
Figure 3. On-Resistance vs. Drain Current and Gate Voltage	Figure 4. Normalized On-Resistance vs. Junction Temperature
	

Figure 5. Typical Transfer Characteristics	Figure 6. Typical Source-Drain Diode Forward Voltage

30
105

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

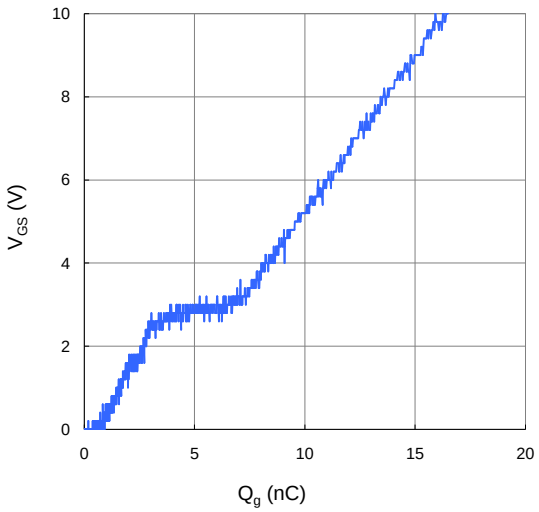


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

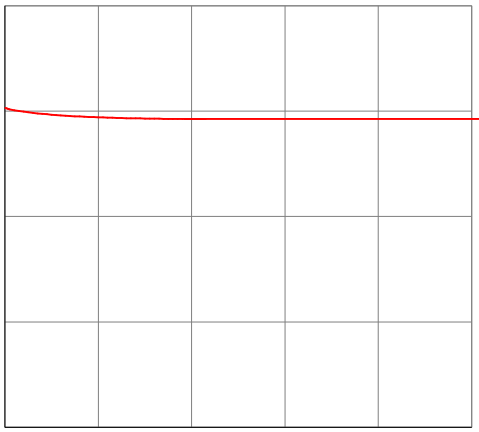


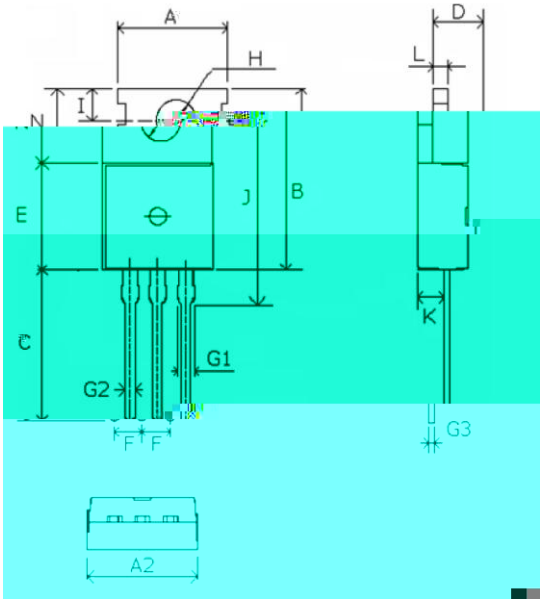
Figure 9. Maximum Safe Operating Area

Figure 10. Maximun Drain Current vs. Case Temperature

Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient

Package Outline

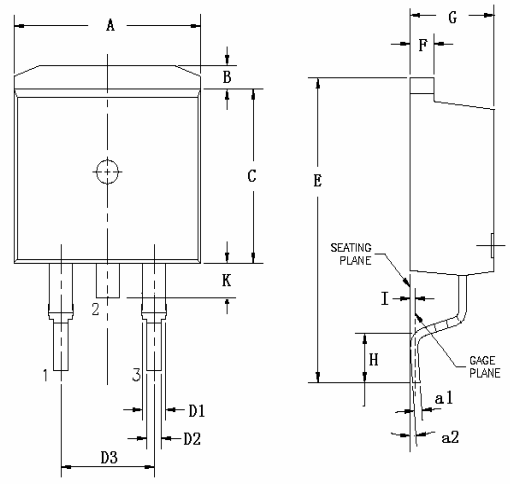
TO-220, 3 leads



Dimentions in mm unless otherwise specified

Symbol	Min	Nom	Max
A	9.66	9.97	10.28
A2	9.80	10.00	10.20
B	15.60	15.70	15.80
C	12.70	13.48	14.27
D	4.30	4.50	4.70
E	9.00	9.20	9.40
F		2.54	
G1	1.32	1.52	1.72
G2	0.70	0.82	0.95
G3	0.45	0.52	0.60
H	3.50	3.60	3.70
I	2.70	2.80	2.90
J	15.70	15.97	16.25
K	2.20	2.40	2.60
L	1.15	1.27	1.40
N	6.40	6.60	6.80

TO-263, 2 leads



Dimentions in mm unless otherwise specified

Symbol	Min	Nom	Max
A	9.66	9.97	10.28
B	1.02	1.17	1.32
C	8.59	9.00	9.40
D1	1.14	1.27	1.40
D2	0.70	0.83	0.95
D3		5.08	
E	15.09	15.24	15.39
F	1.15	1.28	1.40
G	4.30	4.50	4.70
H	2.29	2.54	2.79
I		0.25	
K	1.30	1.45	1.60
a1	0.45	0.55	0.65
a2(degree)	/		